

UNISONIC TECHNOLOGIES CO., LTD

10N50K-MT

Preliminary

Power MOSFET

10A, 500V N-CHANNEL POWER MOSFET

■ DESCRIPTION

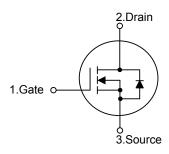
The UTC 10N50K-MT is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **10N50K-MT** is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

■ FEATURES

- * $R_{DS(ON)}$ < 0.68 Ω @ V_{GS} = 10V, I_D = 5 A
- * High Switching Speed
- * 100% Avalanche Tested

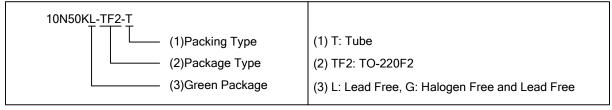
■ SYMBOL



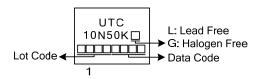
ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking
Lead Free	Halogen Free	Package	1	2	3	Packing
10N50KL-TF2-T	10N50KG-TF2-T	TO-220F2	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



TO-220F2

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■ **ABSOLUTE MAXIMUM RATINGS** (T_C=25°C, unless otherwise specified)

PAR	PARAMETER		RATINGS	UNIT	
Drain-Source Voltage		$V_{ extsf{DSS}}$	500	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous (T _C =25°C)	I _D	10 (Note 2)	Α	
Drain Current	Pulsed (Note 3)	I _{DM}	40 (Note 2)	Α	
Avalanche Current (No	Avalanche Current (Note 3)		10	Α	
Avalanche Energy	lanche Energy Single Pulsed (Note 4)		400	mJ	
Peak Diode Recovery dv/dt (Note 5)		dv/dt	4.5	V/ns	
Power Dissipation		0	48	W	
Derate above 25°C		P_D	0.38	W/°C	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Drain current limited by maximum junction temperature
- 3. Repetitive Rating: Pulse width limited by maximum junction temperature
- 4. L = 8mH, I_{AS} = 10A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- 5. $I_{SD} \le 10A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	62.5	°C/W	
Junction to Case	θ _{JC}	2.58	°C/W	

■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

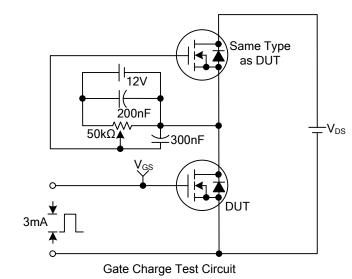
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V	500			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =500V, V _{GS} =0V			10	μA
Gate- Source Leakage Current Forward	I _{GSS}	V_{GS} =+30V, V_{DS} =0V			+100	nA
Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I_D =5A		0.47	0.68	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}			988		pF
Output Capacitance	Coss	V_{GS} =0V, V_{DS} =25V, f=1.0MHz		149		pF
Reverse Transfer Capacitance	C _{RSS}			11		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_G	-\/ -10\/ \/ -50\/ -1.3A		30	60	nC
Gate to Source Charge	Q_GS	V _{GS} =10V, V _{DS} =50V, I _D =1.3A (Note 1, 2)		8.8		nC
Gate to Drain Charge	Q_GD	(Note 1, 2)		7.5		nC
Turn-ON Delay Time	t _{D(ON)}			65	80	ns
Rise Time	t _R	V_{DD} =30V, I_{D} =0.5A, R_{G} =25 Ω		84	75	ns
Turn-OFF Delay Time	t _{D(OFF)}	(Note 1, 2)		179	190	ns
Fall-Time	t _F			85	100	ns
SOURCE- DRAIN DIODE RATINGS AND	CHARACTERI	STICS				
Maximum Body-Diode Continuous Current	Is				10	Α
Maximum Body-Diode Pulsed Current	I _{SM}				40	Α
Drain-Source Diode Forward Voltage	V_{SD}	I _S =10A, V _{GS} =0V			1.4	V

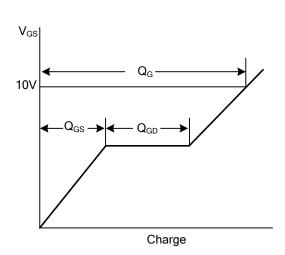
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

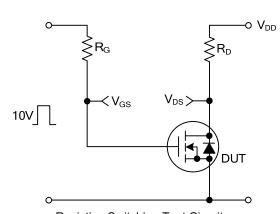


■ TEST CIRCUITS AND WAVEFORMS

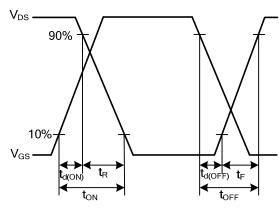




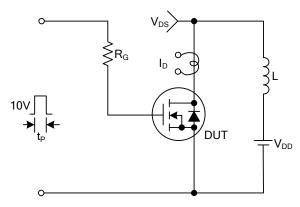
Gate Charge Waveforms



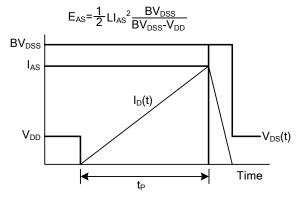




Resistive Switching Waveforms

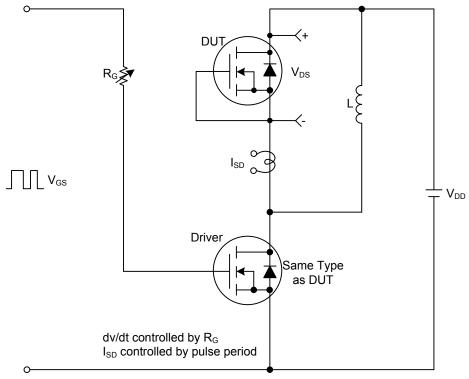


Unclamped Inductive Switching Test Circuit

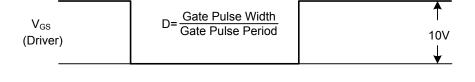


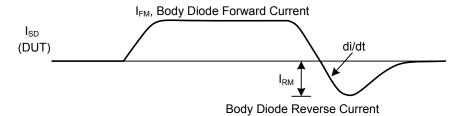
Unclamped Inductive Switching Waveforms

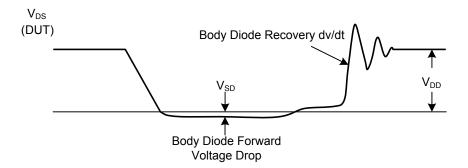
■ TEST CIRCUITS AND WAVEFORMS(Cont.)



Peak Diode Recovery dv/dt Test Circuit & Waveforms







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